# E·XFL

# Intel - EPF10K200SFC672-1 Datasheet



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#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Details	
Product Status	Obsolete
Number of LABs/CLBs	1248
Number of Logic Elements/Cells	9984
Total RAM Bits	98304
Number of I/O	470
Number of Gates	513000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	672-BBGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf10k200sfc672-1

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Similar to the FLEX 10KE architecture, embedded gate arrays are the fastest-growing segment of the gate array market. As with standard gate arrays, embedded gate arrays implement general logic in a conventional "sea-of-gates" architecture. Additionally, embedded gate arrays have dedicated die areas for implementing large, specialized functions. By embedding functions in silicon, embedded gate arrays reduce die area and increase speed when compared to standard gate arrays. While embedded megafunctions typically cannot be customized, FLEX 10KE devices are programmable, providing the designer with full control over embedded megafunctions and general logic, while facilitating iterative design changes during debugging.

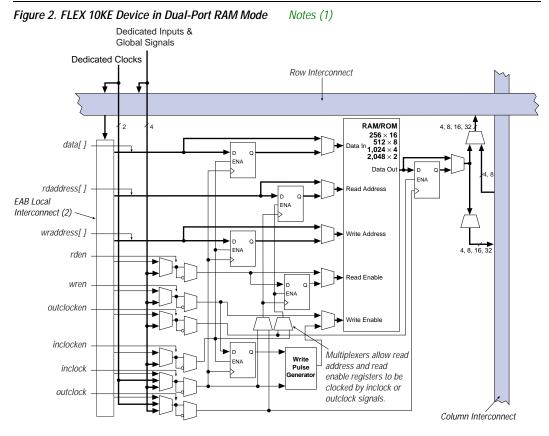
Each FLEX 10KE device contains an embedded array and a logic array. The embedded array is used to implement a variety of memory functions or complex logic functions, such as digital signal processing (DSP), wide data-path manipulation, microcontroller applications, and datatransformation functions. The logic array performs the same function as the sea-of-gates in the gate array and is used to implement general logic such as counters, adders, state machines, and multiplexers. The combination of embedded and logic arrays provides the high performance and high density of embedded gate arrays, enabling designers to implement an entire system on a single device.

FLEX 10KE devices are configured at system power-up with data stored in an Altera serial configuration device or provided by a system controller. Altera offers the EPC1, EPC2, and EPC16 configuration devices, which configure FLEX 10KE devices via a serial data stream. Configuration data can also be downloaded from system RAM or via the Altera BitBlaster<sup>TM</sup>, ByteBlasterMV<sup>TM</sup>, or MasterBlaster download cables. After a FLEX 10KE device has been configured, it can be reconfigured in-circuit by resetting the device and loading new data. Because reconfiguration requires less than 85 ms, real-time changes can be made during system operation.

FLEX 10KE devices contain an interface that permits microprocessors to configure FLEX 10KE devices serially or in-parallel, and synchronously or asynchronously. The interface also enables microprocessors to treat a FLEX 10KE device as memory and configure it by writing to a virtual memory location, making it easy to reconfigure the device.

The EAB can also be used for bidirectional, dual-port memory applications where two ports read or write simultaneously. To implement this type of dual-port memory, two EABs are used to support two simultaneous read or writes.

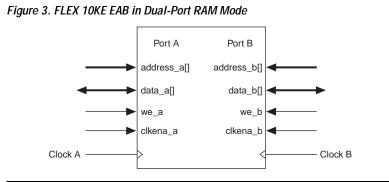
Alternatively, one clock and clock enable can be used to control the input registers of the EAB, while a different clock and clock enable control the output registers (see Figure 2).



#### Notes:

- (1) All registers can be asynchronously cleared by EAB local interconnect signals, global signals, or the chip-wide reset.
- (2) EPF10K30E and EPF10K50E devices have 88 EAB local interconnect channels; EPF10K100E, EPF10K130E, and EPF10K200E devices have 104 EAB local interconnect channels.

The EAB can also use Altera megafunctions to implement dual-port RAM applications where both ports can read or write, as shown in Figure 3.



The FLEX 10KE EAB can be used in a single-port mode, which is useful for backward-compatibility with FLEX 10K designs (see Figure 4).

The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by global signals, general-purpose I/O pins, or any internal logic. For combinatorial functions, the flipflop is bypassed and the output of the LUT drives the output of the LE.

The LE has two outputs that drive the interconnect: one drives the local interconnect and the other drives either the row or column FastTrack Interconnect routing structure. The two outputs can be controlled independently. For example, the LUT can drive one output while the register drives the other output. This feature, called register packing, can improve LE utilization because the register and the LUT can be used for unrelated functions.

The FLEX 10KE architecture provides two types of dedicated high-speed data paths that connect adjacent LEs without using local interconnect paths: carry chains and cascade chains. The carry chain supports high-speed counters and adders and the cascade chain implements wide-input functions with minimum delay. Carry and cascade chains connect all LEs in a LAB as well as all LABs in the same row. Intensive use of carry and cascade chains can reduce routing flexibility. Therefore, the use of these chains should be limited to speed-critical portions of a design.

# Carry Chain

The carry chain provides a very fast (as low as 0.2 ns) carry-forward function between LEs. The carry-in signal from a lower-order bit drives forward into the higher-order bit via the carry chain, and feeds into both the LUT and the next portion of the carry chain. This feature allows the FLEX 10KE architecture to implement high-speed counters, adders, and comparators of arbitrary width efficiently. Carry chain logic can be created automatically by the Altera Compiler during design processing, or manually by the designer during design entry. Parameterized functions such as LPM and DesignWare functions automatically take advantage of carry chains.

Carry chains longer than eight LEs are automatically implemented by linking LABs together. For enhanced fitting, a long carry chain skips alternate LABs in a row. A carry chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from oddnumbered LAB to odd-numbered LAB. For example, the last LE of the first LAB in a row carries to the first LE of the third LAB in the row. The carry chain does not cross the EAB at the middle of the row. For instance, in the EPF10K50E device, the carry chain stops at the eighteenth LAB and a new one begins at the nineteenth LAB.

#### Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a four-input LUT. The Altera Compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. Either the register or the LUT can be used to drive both the local interconnect and the FastTrack Interconnect routing structure at the same time.

The LUT and the register in the LE can be used independently (register packing). To support register packing, the LE has two outputs; one drives the local interconnect, and the other drives the FastTrack Interconnect routing structure. The DATA4 signal can drive the register directly, allowing the LUT to compute a function that is independent of the registered signal; a three-input function can be computed in the LUT, and a fourth independent signal can be registered. Alternatively, a four-input function can be generated, and one of the inputs to this function can be used to drive the register. The register in a packed LE can still use the clock enable, clear, and preset signals in the LE. In a packed LE, the register can drive the FastTrack Interconnect routing structure while the LUT drives the local interconnect, or vice versa.

# Arithmetic Mode

The arithmetic mode offers 2 three-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT computes a three-input function; the other generates a carry output. As shown in Figure 11 on page 22, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three signals: a, b, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

# **Up/Down Counter Mode**

The up/down counter mode offers counter enable, clock enable, synchronous up/down control, and data loading options. These control signals are generated by the data inputs from the LAB local interconnect, the carry-in signal, and output feedback from the programmable register. Use 2 three-input LUTs: one generates the counter data, and the other generates the fast carry bit. A 2-to-1 multiplexer provides synchronous loading. Data can also be loaded asynchronously with the clear and preset register control signals without using the LUT resources.

#### **Asynchronous Clear**

The flipflop can be cleared by either LABCTRL1 or LABCTRL2. In this mode, the preset signal is tied to VCC to deactivate it.

#### **Asynchronous Preset**

An asynchronous preset is implemented as an asynchronous load, or with an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a one into the register. Alternatively, the Altera software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

# **Asynchronous Preset & Clear**

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. DATA3 is tied to VCC, so that asserting LABCTRL1 asynchronously loads a one into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

# Asynchronous Load with Clear

When implementing an asynchronous load in conjunction with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear; LABCTRL2 does not have to feed the preset circuits.

# **Asynchronous Load with Preset**

When implementing an asynchronous load in conjunction with preset, the Altera software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 presets the register, while asserting LABCTRL1 loads the register. The Altera software inverts the signal that drives DATA3 to account for the inversion of the register's output.

# Asynchronous Load without Preset or Clear

When implementing an asynchronous load without preset or clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

Peripheral Control Signal	EPF10K100E	EPF10K130E	EPF10K200E EPF10K200S
OE0	Row A	Row C	Row G
OE1	Row C	Row E	Row I
OE2	Row E	Row G	Row K
OE 3	Row L	Row N	Row R
OE4	Row I	Row K	Row O
OE5	Row K	Row M	Row Q
CLKENA0/CLK0/GLOBAL0	Row F	Row H	Row L
CLKENA1/OE6/GLOBAL1	Row D	Row F	Row J
CLKENA2/CLR0	Row B	Row D	Row H
CLKENA3/OE7/GLOBAL2	Row H	Row J	Row N
CLKENA4/CLR1	Row J	Row L	Row P
CLKENA5/CLK1/GLOBAL3	Row G	Row I	Row M

Signals on the peripheral control bus can also drive the four global signals, referred to as GLOBAL0 through GLOBAL3 in Tables 8 and 9. An internally generated signal can drive a global signal, providing the same low-skew, low-delay characteristics as a signal driven by an input pin. An LE drives the global signal by driving a row line that drives the peripheral bus, which then drives the global signal. This feature is ideal for internally generated clear or clock signals with high fan-out. However, internally driven global signals offer no advantage over the general-purpose interconnect for routing data signals. The dedicated input pin should be driven to a known logic state (such as ground) and not be allowed to float.

The chip-wide output enable pin is an active-high pin (DEV\_OE) that can be used to tri-state all pins on the device. This option can be set in the Altera software. On EPF10K50E and EPF10K200E devices, the built-in I/O pin pull-up resistors (which are active during configuration) are active when the chip-wide output enable pin is asserted. The registers in the IOE can also be reset by the chip-wide reset pin.

Figure 22 shows the required relationship between  $V_{CCIO}$  and  $V_{CCINT}$  for 3.3-V PCI compliance.

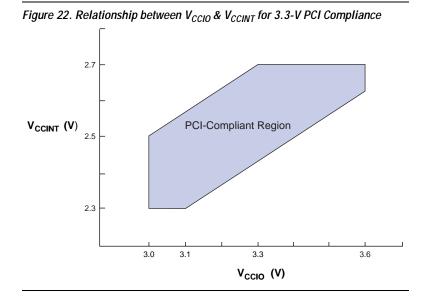
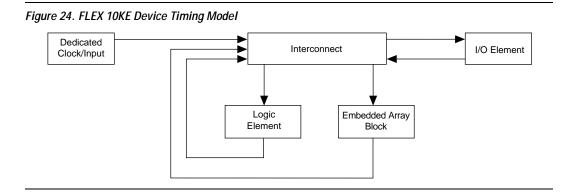


Figure 23 shows the typical output drive characteristics of FLEX 10KE devices with 3.3-V and 2.5-V V<sub>CCIO</sub>. The output driver is compliant to the 3.3-V *PCI Local Bus Specification*, *Revision 2.2* (when VCCIO pins are connected to 3.3 V). FLEX 10KE devices with a -1 speed grade also comply with the drive strength requirements of the *PCI Local Bus Specification*, *Revision 2.2* (when VCCINT pins are powered with a minimum supply of 2.375 V, and VCCIO pins are connected to 3.3 V). Therefore, these devices can be used in open 5.0-V PCI systems.

#### **Altera Corporation**

Timing simulation and delay prediction are available with the Altera Simulator and Timing Analyzer, or with industry-standard EDA tools. The Simulator offers both pre-synthesis functional simulation to evaluate logic design accuracy and post-synthesis timing simulation with 0.1-ns resolution. The Timing Analyzer provides point-to-point timing delay information, setup and hold time analysis, and device-wide performance analysis.

Figure 24 shows the overall timing model, which maps the possible paths to and from the various elements of the FLEX 10KE device.



Figures 25 through 28 show the delays that correspond to various paths and functions within the LE, IOE, EAB, and bidirectional timing models.

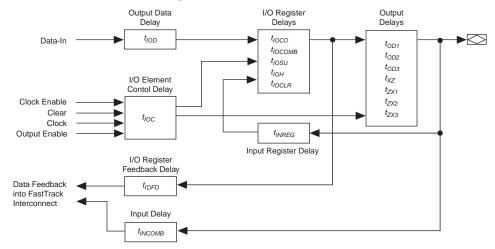
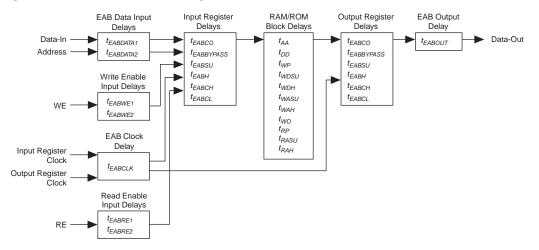


Figure 26. FLEX 10KE Device IOE Timing Model

Figure 27. FLEX 10KE Device EAB Timing Model



Figures 29 and 30 show the asynchronous and synchronous timing waveforms, respectively, or the EAB macroparameters in Tables 26 and 27.

EAB Asynchronous Read WE \_ a0 a2 Address a1 a3 – t<sub>EABAA</sub>t<sub>EABRCCOMB</sub> Data-Out d0 d3 d1 d2 **EAB Asynchronous Write** WE  $t_{EABWP}$ ► t<sub>EABWDH</sub> t<sub>EABWDSU</sub> Þ. din0 din1 Data-In t<sub>EABWASU</sub> t<sub>EABWAH</sub> t<sub>EABWCCOMB</sub> Address a0 a1 a2  $t_{EABDD}$ Data-Out din0 din1 dout2

#### Figure 29. EAB Asynchronous Timing Waveforms

Symbol	-1 Spee	d Grade	-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		1.7		2.0		2.3	ns
t <sub>EABDATA1</sub>		0.6		0.7		0.8	ns
t <sub>EABWE1</sub>		1.1		1.3		1.4	ns
t <sub>EABWE2</sub>		0.4		0.4		0.5	ns
t <sub>EABRE1</sub>		0.8		0.9		1.0	ns
t <sub>EABRE2</sub>		0.4		0.4		0.5	ns
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns
t <sub>EABCO</sub>		0.3		0.3		0.4	ns
t <sub>EABBYPASS</sub>		0.5		0.6		0.7	ns
t <sub>EABSU</sub>	0.9		1.0		1.2		ns
t <sub>EABH</sub>	0.4		0.4		0.5		ns
t <sub>EABCLR</sub>	0.3		0.3		0.3		ns
t <sub>AA</sub>		3.2		3.8		4.4	ns
t <sub>WP</sub>	2.5		2.9		3.3		ns
t <sub>RP</sub>	0.9		1.1		1.2		ns
t <sub>WDSU</sub>	0.9		1.0		1.1		ns
t <sub>WDH</sub>	0.1		0.1		0.1		ns
t <sub>WASU</sub>	1.7		2.0		2.3		ns
t <sub>WAH</sub>	1.8		2.1		2.4		ns
t <sub>RASU</sub>	3.1		3.7		4.2		ns
t <sub>RAH</sub>	0.2		0.2		0.2		ns
t <sub>WO</sub>		2.5		2.9		3.3	ns
t <sub>DD</sub>		2.5		2.9		3.3	ns
t <sub>EABOUT</sub>		0.5		0.6		0.7	ns
t <sub>EABCH</sub>	1.5		2.0		2.3		ns
t <sub>EABCL</sub>	2.5		2.9		3.3		ns

Table 37. EPF10K	30E Externa	I Bidirection	nal Timing P	arameters	Notes (1),	Notes (1), (2)		
Symbol	-1 Speed Grade		-2 Spee	-2 Speed Grade		d Grade	Unit	
	Min	Max	Min	Max	Min	Max		
t <sub>INSUBIDIR</sub> (3)	2.8		3.9		5.2		ns	
t <sub>INHBIDIR</sub> (3)	0.0		0.0		0.0		ns	
t <sub>INSUBIDIR</sub> (4)	3.8		4.9		-		ns	
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-		ns	
t <sub>OUTCOBIDIR</sub> (3)	2.0	4.9	2.0	5.9	2.0	7.6	ns	
t <sub>XZBIDIR</sub> (3)		6.1		7.5		9.7	ns	
t <sub>ZXBIDIR</sub> (3)		6.1		7.5		9.7	ns	
t <sub>OUTCOBIDIR</sub> (4)	0.5	3.9	0.5	4.9	-	-	ns	
t <sub>XZBIDIR</sub> (4)		5.1		6.5		-	ns	
t <sub>ZXBIDIR</sub> (4)		5.1		6.5		-	ns	

# Notes to tables:

(1) All timing parameters are described in Tables 24 through 30 in this data sheet.

(2) These parameters are specified by characterization.

(3) This parameter is measured without the use of the ClockLock or ClockBoost circuits.

(4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

# Tables 38 through 44 show EPF10K50E device internal and external timing parameters.

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Мах	Min	Мах	Min	Max	
t <sub>LUT</sub>		0.6		0.9		1.3	ns
t <sub>CLUT</sub>		0.5		0.6		0.8	ns
t <sub>RLUT</sub>		0.7		0.8		1.1	ns
t <sub>PACKED</sub>		0.4		0.5		0.6	ns
t <sub>EN</sub>		0.6		0.7		0.9	ns
t <sub>CICO</sub>		0.2		0.2		0.3	ns
t <sub>CGEN</sub>		0.5		0.5		0.8	ns
t <sub>CGENR</sub>		0.2		0.2		0.3	ns
t <sub>CASC</sub>		0.8		1.0		1.4	ns
t <sub>C</sub>		0.5		0.6		0.8	ns
t <sub>CO</sub>		0.7		0.7		0.9	ns
t <sub>COMB</sub>		0.5		0.6		0.8	ns
t <sub>SU</sub>	0.7		0.7		0.8		ns

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Symbol	-1 Spee	ed Grade	-2 Spee	-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DRR</sub>		9.0		12.0		16.0	ns
t <sub>INSU</sub> (3)	2.0		2.5		3.3		ns
t <sub>INH</sub> (3)	0.0		0.0		0.0		ns
t <sub>оитсо</sub> (3)	2.0	5.2	2.0	6.9	2.0	9.1	ns
t <sub>INSU</sub> (4)	2.0		2.2		-		ns
t <sub>INH</sub> (4)	0.0		0.0		-		ns
t <sub>оитсо</sub> (4)	0.5	3.0	0.5	4.6	-	-	ns
t <sub>PCISU</sub>	3.0		6.2		-		ns
t <sub>PCIH</sub>	0.0		0.0		-		ns
t <sub>PCICO</sub>	2.0	6.0	2.0	6.9	-	_	ns

 Table 51. EPF10K100E External Bidirectional Timing Parameters
 Notes (1), (2)

Symbol	-1 Spee	ed Grade	-2 Spee	-2 Speed Grade		-3 Speed Grade	
	Min	Max	Min	Max	Min	Max	
t <sub>INSUBIDIR</sub> (3)	1.7		2.5		3.3		ns
t <sub>inhbidir</sub> (3)	0.0		0.0		0.0		ns
t <sub>INSUBIDIR</sub> (4)	2.0		2.8		-		ns
t <sub>INHBIDIR</sub> (4)	0.0		0.0		-		ns
toutcobidir (3)	2.0	5.2	2.0	6.9	2.0	9.1	ns
t <sub>XZBIDIR</sub> (3)		5.6		7.5		10.1	ns
t <sub>ZXBIDIR</sub> (3)		5.6		7.5		10.1	ns
toutcobidir (4)	0.5	3.0	0.5	4.6	-	-	ns
t <sub>XZBIDIR</sub> (4)		4.6		6.5		-	ns
t <sub>ZXBIDIR</sub> (4)		4.6		6.5		-	ns

#### Notes to tables:

(1) All timing parameters are described in Tables 24 through 30 in this data sheet.

(2) These parameters are specified by characterization.

(3) This parameter is measured without the use of the ClockLock or ClockBoost circuits.

(4) This parameter is measured with the use of the ClockLock or ClockBoost circuits.

Symbol	-1 Spee	d Grade	-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		2.0		2.4		3.2	ns
t <sub>EABDATA1</sub>		0.4		0.5		0.6	ns
t <sub>EABWE1</sub>		1.4		1.7		2.3	ns
t <sub>EABWE2</sub>		0.0		0.0		0.0	ns
t <sub>EABRE1</sub>		0		0		0	ns
t <sub>EABRE2</sub>		0.4		0.5		0.6	ns
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns
t <sub>EABCO</sub>		0.8		0.9		1.2	ns
t <sub>EABBYPASS</sub>		0.0		0.1		0.1	ns
t <sub>EABSU</sub>	0.9		1.1		1.5		ns
t <sub>EABH</sub>	0.4		0.5		0.6		ns
t <sub>EABCLR</sub>	0.8		0.9		1.2		ns
t <sub>AA</sub>		3.1		3.7		4.9	ns
t <sub>WP</sub>	3.3		4.0		5.3		ns
t <sub>RP</sub>	0.9		1.1		1.5		ns
t <sub>WDSU</sub>	0.9		1.1		1.5		ns
t <sub>WDH</sub>	0.1		0.1		0.1		ns
t <sub>WASU</sub>	1.3		1.6		2.1		ns
t <sub>WAH</sub>	2.1		2.5		3.3		ns
t <sub>RASU</sub>	2.2		2.6		3.5		ns
t <sub>RAH</sub>	0.1		0.1		0.2		ns
t <sub>WO</sub>		2.0		2.4		3.2	ns
t <sub>DD</sub>		2.0		2.4		3.2	ns
t <sub>EABOUT</sub>		0.0		0.1		0.1	ns
t <sub>EABCH</sub>	1.5		2.0		2.5		ns
t <sub>EABCL</sub>	3.3		4.0		5.3	İ	ns

Table 62. EPF10K200E Device EAB Internal Timing Macroparameters (Part 1 of 2)

Note	(1)
	(1)

Symbol	-1 Speed Grade		-2 Spee	d Grade	-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		5.1		6.4		8.4	ns
t <sub>EABRCOMB</sub>	5.1		6.4		8.4		ns
t <sub>EABRCREG</sub>	4.8		5.7		7.6		ns
t <sub>EABWP</sub>	3.3		4.0		5.3		ns

Symbol	-1 Spee	d Grade	-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABDATA1</sub>		1.7		2.4		3.2	ns
t <sub>EABDATA2</sub>		0.4		0.6		0.8	ns
t <sub>EABWE1</sub>		1.0		1.4		1.9	ns
t <sub>EABWE2</sub>		0.0		0.0		0.0	ns
t <sub>EABRE1</sub>		0.0		0.0		0.0	
t <sub>EABRE2</sub>		0.4		0.6		0.8	
t <sub>EABCLK</sub>		0.0		0.0		0.0	ns
t <sub>EABCO</sub>		0.8		1.1		1.5	ns
t <sub>EABBYPASS</sub>		0.0		0.0		0.0	ns
t <sub>EABSU</sub>	0.7		1.0		1.3		ns
t <sub>EABH</sub>	0.4		0.6		0.8		ns
t <sub>EABCLR</sub>	0.8		1.1		1.5		
t <sub>AA</sub>		2.0		2.8		3.8	ns
t <sub>WP</sub>	2.0		2.8		3.8		ns
t <sub>RP</sub>	1.0		1.4		1.9		
t <sub>WDSU</sub>	0.5		0.7		0.9		ns
t <sub>WDH</sub>	0.1		0.1		0.2		ns
t <sub>WASU</sub>	1.0		1.4		1.9		ns
t <sub>WAH</sub>	1.5		2.1		2.9		ns
t <sub>RASU</sub>	1.5		2.1		2.8		
t <sub>RAH</sub>	0.1		0.1		0.2		
t <sub>WO</sub>		2.1		2.9		4.0	ns
t <sub>DD</sub>		2.1		2.9		4.0	ns
t <sub>EABOUT</sub>		0.0		0.0		0.0	ns
t <sub>EABCH</sub>	1.5		2.0		2.5		ns
t <sub>EABCL</sub>	1.5		2.0		2.5	İ	ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>EABAA</sub>		3.7		5.2		7.0	ns
t <sub>EABRCCOMB</sub>	3.7		5.2		7.0		ns
t <sub>EABRCREG</sub>	3.5		4.9		6.6		ns
t <sub>EABWP</sub>	2.0		2.8		3.8		ns
t <sub>EABWCCOMB</sub>	4.5		6.3		8.6		ns
t <sub>EABWCREG</sub>	5.6		7.8		10.6		ns
t <sub>EABDD</sub>		3.8		5.3		7.2	ns
t <sub>EABDATACO</sub>		0.8		1.1		1.5	ns
t <sub>EABDATASU</sub>	1.1		1.6		2.1		ns
t <sub>EABDATAH</sub>	0.0		0.0		0.0		ns
t <sub>EABWESU</sub>	0.7		1.0		1.3		ns
t <sub>EABWEH</sub>	0.4		0.6		0.8		ns
t <sub>EABWDSU</sub>	1.2		1.7		2.2		ns
t <sub>EABWDH</sub>	0.0		0.0		0.0		ns
t <sub>EABWASU</sub>	1.6		2.3		3.0		ns
t <sub>EABWAH</sub>	0.9		1.2		1.8		ns
t <sub>EABWO</sub>		3.1		4.3		5.9	ns

Table 70. EPF10	K50S Device	Interconnec	t Timing Mi	croparamete	e <b>rs</b> Note	(1)	
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>DIN2IOE</sub>		3.1		3.7		4.6	ns
t <sub>DIN2LE</sub>		1.7		2.1		2.7	ns
t <sub>DIN2DATA</sub>		2.7		3.1		5.1	ns
t <sub>DCLK2IOE</sub>		1.6		1.9		2.6	ns
t <sub>DCLK2LE</sub>		1.7		2.1		2.7	ns
t <sub>SAMELAB</sub>		0.1		0.1		0.2	ns
t <sub>SAMEROW</sub>		1.5		1.7		2.4	ns
t <sub>SAMECOLUMN</sub>		1.0		1.3		2.1	ns
t <sub>DIFFROW</sub>		2.5		3.0		4.5	ns
t <sub>TWOROWS</sub>		4.0		4.7		6.9	ns
t <sub>LEPERIPH</sub>		2.6		2.9		3.4	ns
t <sub>LABCARRY</sub>		0.1		0.2		0.2	ns
t <sub>LABCASC</sub>		0.8		1.0		1.3	ns

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Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>LUT</sub>		0.7		0.8		1.2	ns
t <sub>CLUT</sub>		0.4		0.5		0.6	ns
t <sub>RLUT</sub>		0.5		0.7		0.9	ns
t <sub>PACKED</sub>		0.4		0.5		0.7	ns
t <sub>EN</sub>		0.6		0.5		0.6	ns
tcico		0.1		0.2		0.3	ns
t <sub>CGEN</sub>		0.3		0.4		0.6	ns
t <sub>CGENR</sub>		0.1		0.2		0.3	ns
t <sub>CASC</sub>		0.7		0.8		1.2	ns
t <sub>C</sub>		0.5		0.6		0.8	ns
<sup>t</sup> co		0.5		0.6		0.8	ns
tсомв		0.3		0.6		0.8	ns
t <sub>SU</sub>	0.4		0.6		0.7		ns
tн	1.0		1.1		1.5		ns
t <sub>PRE</sub>		0.4		0.6		0.8	ns
t <sub>CLR</sub>		0.5		0.6		0.8	ns
<sup>t</sup> CH	2.0		2.5		3.0		ns
ĊL	2.0		2.5		3.0		ns

 Table 74. EPF10K200S Device IOE Timing Microparameters (Part 1 of 2)
 Note (1)

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t <sub>IOD</sub>		1.8		1.9		2.6	ns
t <sub>IOC</sub>		0.3		0.3		0.5	ns
t <sub>IOCO</sub>		1.7		1.9		2.6	ns
t <sub>IOCOMB</sub>		0.5		0.6		0.8	ns
t <sub>IOSU</sub>	0.8		0.9		1.2		ns
t <sub>IOH</sub>	0.4		0.8		1.1		ns
t <sub>IOCLR</sub>		0.2		0.2		0.3	ns
t <sub>OD1</sub>		1.3		0.7		0.9	ns
t <sub>OD2</sub>		0.8		0.2		0.4	ns
t <sub>OD3</sub>		2.9		3.0		3.9	ns
t <sub>XZ</sub>		5.0		5.3		7.1	ns
t <sub>ZX1</sub>		5.0		5.3		7.1	ns

Additionally, the Altera software offers several features that help plan for future device migration by preventing the use of conflicting I/O pins.

Table 81. I/O Counts for FLEX 10KA & FLEX 10KE Devices					
FLEX 10	KA	FLEX 10	KE		
Device	I/O Count	Device	I/O Count		
EPF10K30AF256	191	EPF10K30EF256	176		
EPF10K30AF484	246	EPF10K30EF484	220		
EPF10K50VB356	274	EPF10K50SB356	220		
EPF10K50VF484	291	EPF10K50EF484	254		
EPF10K50VF484	291	EPF10K50SF484	254		
EPF10K100AF484	369	EPF10K100EF484	338		

**Configuration Schemes** 

The configuration data for a FLEX 10KE device can be loaded with one of five configuration schemes (see Table 82), chosen on the basis of the target application. An EPC1, EPC2, or EPC16 configuration device, intelligent controller, or the JTAG port can be used to control the configuration of a FLEX 10KE device, allowing automatic configuration on system power-up.

Multiple FLEX 10KE devices can be configured in any of the five configuration schemes by connecting the configuration enable (nCE) and configuration enable output (nCEO) pins on each device. Additional FLEX 10K, FLEX 10KA, FLEX 10KE, and FLEX 6000 devices can be configured in the same serial chain.

Table 82. Data Sources for FLEX 10KE Configuration				
Configuration Scheme	Data Source			
Configuration device	EPC1, EPC2, or EPC16 configuration device			
Passive serial (PS)	BitBlaster, ByteBlasterMV, or MasterBlaster download cables, or serial data source			
Passive parallel asynchronous (PPA)	Parallel data source			
Passive parallel synchronous (PPS)	Parallel data source			
JTAG	BitBlaster or ByteBlasterMV download cables, or microprocessor with a Jam STAPL file or JBC file			

Device Pin-Outs	See the Altera web site (http://www.altera.com) or the Altera Digital Library for pin-out information.	
Revision History	The information contained in the <i>FLEX 10KE Embedded Programmable Log Data Sheet</i> version 2.5 supersedes information published in previous versions.	
	Version 2.5	
	The following changes were made to the <i>FLEX 10KE Embedded Programmable Logic Data Sheet</i> version 2.5:	
	<ul> <li><i>Note (1)</i> added to Figure 23.</li> <li>Text added to "I/O Element" section on page 34.</li> <li>Updated Table 22.</li> </ul>	
	Version 2.4	
	The following changes were made to the FLEX 10KE Embedded	

Programmable Logic Data Sheet version 2.4: updated text on page 34 and page 63.